#### Certificate of Mailing

<u>IB 621 467 10X US</u> "Express Mail" mailing number

May 4, 2001 Date of Deposit

I hereby certify that this application is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademark, Washington, D.C. 20231.

Steven M. Mitchell (Typed or printed name of person mailing application)

(SigNature of person mailing application)

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Date: May 4, 2001

Hemphill, et al.

Serial No: to be assigned

Group Art Unit: not known

Filed: herewith

Examiner: not yet known

For: "Non-Uniform Etching Of Anode Foil To Produce Higher Capacitance Gain Without Sacrificing Foil Strength"

### PRELIMINARY AMENDMENT

Honorable Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Please amend the above-captioned patent application as follows:

In the specification:

On page 3, please replace paragraph 7 with the following rewritten paragraph:

The ideal etching structure is a pure tunnel-like etch with defined and uniform tunnel diameters and without any undesirable pitting of the foil. As tunnel density (i.e., the number of tunnels per square centimeter) is increased, a corresponding enlargement of the overall surface area will occur. Larger surface area results in higher overall capacitance. However, as tunnel density increases, more of the aluminum foil is removed, reducing the strength of the remaining foil. Therefore a compromise must be made between foil strength and capacitance gain.

Attached hereto is a marked-up version of the changes made to the specification by the preliminary amendment. The attachment is captioned "VERSION WITH MARKINGS TO SHOW CHANGES MADE".

Please charge any fees or credit overpayment to Deposit Account No. 22-0265. If any addition extension fee is required, please charge to Deposit Account No. 22-0265. This form is submitted in triplicate.

Respectfully submitted,

PACESETTER, INC. 701 E. Evelyn Avenue Sunnyvale, CA 94086 Telephone: (408) 522-6101

Date: May 4, 2001

Steven M. Mitchell Reg. No. 31,857 Attorney for Applicant

### **VERSION WITH MARKINGS TO SHOW CHANGES MADE**

In the specification:

On page 3, paragraph 7 has been amended as follows:

The ideal etching structure is a pure tunnel-like etch with defined and uniform tunnel diameters and without any undesirable pitting of the foil. As tunnel density (*i.e.*, the number of tunnels per square centimeter) is increased, a corresponding enlargement of the overall surface area will occur. Larger surface area results in higher overall capacitance. However, as tunnel density increases, more of the aluminum foil is removed, reducing the strength of the remaining foil. Therefore a [comprise] compromise must be made between foil strength and capacitance gain.

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